

JC892 U.S. PTO  
01/14/02

1-17-02  
A11  
Atty. Docket No. AMAT/5908/CPI/AL/WIRE/PJ8

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Box Patent Application  
Assistant Commissioner of Patents and Trademarks  
Washington, D.C. 20231

Re: Inventor(s): HOUGONG WANG; KENNY KING-TAI NGAN and ZHENG XU  
Title: SEMICONDUCTOR WAFER PREHEATING

Jc971 U.S. PTO  
10/046954  
01/14/02

Transmitted herewith is the patent application identified above, including:

- ☒ Specification, claims and abstract, totaling 27 pages.  
☒ Drawings totaling 5 pages, ☒ Formal ☐ Informal.  
☒ Executed Declaration and Power of Attorney.  
☐ Information Disclosure Statement w/ Form 1449 and References.  
☒ Assignment of the invention to **Applied Materials, Inc.**  
☒ Assignment Recordation Cover Sheet

FEE CALCULATION					
Fee Items	Claims Filed	Included With Basic Fee	Extra Claims	Fee Rate	Total
Total Claims	64	-20=	44	x \$18.00	-\$792.00
Independent Claims	4	-3=	1	x \$84.00	-\$ 84.00
Basic Filing Fee				\$740.00	\$ 740.00
TOTAL FEES					\$1,616.00

- ☒ The Commissioner is hereby authorized to charge **\$1,616.00** to Deposit Account No. **50-1074/5908/CPI/AL WIRE/PJS**.  
☒ The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. **50-1074/5908/CPI/AL WIRE/PJS**. A duplicate copy of this transmittal is enclosed.  
☒ Please address all future correspondence to:

**PATENT COUNSEL  
APPLIED MATERIALS, INC.  
Legal Affairs Department  
P.O.BOX 450A  
Santa Clara, CA 95052**

I hereby certify that this correspondence is being deposited with the United States Postal Service as express mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231.

Express Mail Receipt No. EL849164562US

Date of Deposit 1-14-02

Signature Robert W. Mulcahy

Respectfully submitted,

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